3M[™] Thermally Conductive Epoxy Adhesive TC-2707

Product Description

3MTM Thermally Conductive Epoxy Adhesive TC-2707 is an aluminum metal filled, two-part, thermally conductive epoxy adhesive.

Key Features

- Improved thermal conductivity.
- Curing performance comparable to 3M™ Scotch-Weld™ Epoxy Adhesive DP-460 and DP-460 EG.
- Low outgassing comparable to Scotch-Weld DP-460 EG.
- Lower chloride ion content than standard epoxies.

Typical Uncured Properties

Note: The following technical information and data should be considered representative or typical only and should not be used for specification purposes.

Product		3M™ Thermally Conductive Epoxy Adhesive TC-2707
Viscosity	Base Accelerator Mixed	170,000 cps 25,000 cps 100,000 cps
Base Resin	Base Accelerator	Epoxy Amine
Filler	Aluminum	50% by weight
Mix Ratio (B:A)	Volume Weight	2:1 2.00 : 0.96
Worklife		60 minutes at 72°F (23°C)



Typical Cured Properties

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Product	3M™ Thermally Conductive Epoxy Adhesive TC-2707	
Color	Gray	
Shore D Hardness	84	
Glass Transition Temperature	60°C (tan delta) See Chart on page 3	
Thermal Coefficient of Expansion	$56 \times 10^{-6}/^{\circ}\text{C}$ (below T_g) 132 x $10^{-6}/^{\circ}\text{C}$ (above T_g)	
Thermal Conductivity	0.72 W/m-°K	
Thermal Impedance	3.51 x 10 ⁻⁵ m ² °K/W (1 mil)	
Volume Resistivity ¹	1.6 x 10 ¹¹ ohm-cm	
Total Outgassing	<25 micro-gm/gm (GC/MS, 85°C/3 hours)	
Hydrocarbon Outgassing	<25 micro-gm/gm (GC/MS, 85°C/3 hours)	
Siloxane Outgassing	<2 micro-gm/gm (GC/MS, 85°C/3 hours)	
Extractable Siloxane	<10 micro-gm/gm (hexane extraction)	
Extractable Chloride	<10 micro-gm/gm (hexane extraction)	

¹¹) As the 3M™ Thermally Conductive Epoxy Adhesive TC-2707 uses aluminum metal fillers, under certain end use application conditions the effective resistivity and/or effective dielectric strength could be significantly lower than noted. If the metal fillers are "trapped" or "pinched" between two surfaces, an electrical bridge path via the aluminum fillers could occur between these surfaces. Epoxy Adhesive TC-2707 is not suggested for applications where a powered electrical circuit is used or where a reliable volume resistivity and/or dielectric strength is desired. 3M™ Thermally Conductive Epoxy Adhesive TC-2810 uses a ceramic filler and is a suggested product to test for these type of application performance needs.

Curing

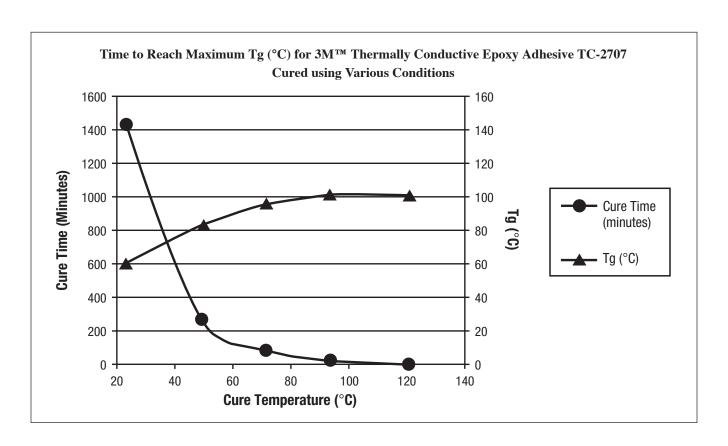
Cure Schedule: 23°C/24 hours

50°C/270 minutes 70°C/90 minutes 90°C/30 minutes 120°C/10 minutes

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Shear Strength, Peel Strength, Tg vs. Cure Temperature/Time

	72°F (23°C) 24 hours	122°F (50°C) 270 minutes	158°F (70°C) 90 minutes	194°F (90°C) 30 minutes	248°F (120°C) 10 minutes
Overlap Shear (psi) (ASTM D-1002)	>3000	>3000	>3000	>4000	>4000
T-Peel (piw) (ASTM D-1876)	>7	>7	>7	>7	>7
Tg (°C) Tan Delta	60	83	95	100	100
Tg (°C) Storage Modulus	48	73	85	86	89



Application and Product Use Notes

For bonding rigid to rigid parts it is suggested that the bond line thickness and edge fillet be designed to optimize:

- i) Bond Strength;
- ii) Thermal Resistance.

A typical suggested bond line is in the 3-7mil thickness range

For improved thermal performance (lower Thermal Resistance), a thinner bond line is suggested. A thinner bond line can reduce the bond strength so each application needs to be tested to find the correct balance between:

"Bond Line Thickness vs. Thermal Resistance vs. Bond Strength"

A "fillet" at the edges of a bond line is suggested to increase bond strength. The fillets are formed as the epoxy squeezes out past the side edges. Fillets can add strength to the assembly.

3MTM Thermally Conductive Epoxy TC-2707 is supplied in dual syringe plastic duo-pak cartridges as part of the 3MTM EPXTM Applicator System. The duo-pak cartridges are supplied in a 37 ml configuration. To use the 37 ml cartridge simply insert the duo-pak cartridge into the EPX applicator and start the plunger into the cylinders using light pressure on the trigger. Next, remove the duo-pak cartridge cap and expel and discard a small amount of adhesive to be sure both sides of the duo-pak cartridge are flowing evenly and freely (ie: no voids, "plugs of adhesive", dis-continuity in flow, etc.) Once even side to side and uniform flow from both sides of the duo-pak is confirmed, attach the 3MTM EPXTM Mixing Nozzle to the duo-pak cartridge to ensure proper and uniform mixing of the Part A and Part B and begin dispensing the adhesive.

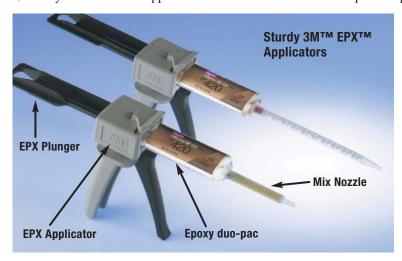
With a 200mil cartridge, the nozzle must be attached before dispensing any material to prevent unmixed adhesive from getting into the applicator cartridge holder. A quantity of material should be dispensed through the mix nozzle and discarded until a uniform color, consistency of product, freely flowing and even side to side flow is evident.

Partially used cartridges must follow the above use instructions to ensure consistent product performance.

Complete and uniform mixing as noted above of the two components is required to obtain consistent product performance.

3M™ EPX™ Applicator and Mix Nozzles

Use only 3MTM EPXTM Applicator and Mix Nozzles to ensure optimum product performance.



Storage and Shelf Life

Storage: Store 3M[™] Thermally Conductive Epoxy Adhesive TC-2707 at 60-80°F (15-27°C) or refrigerate for maximum shelf life and to reduce filler settling.

Shelf Life: Epoxy Adhesive TC-2707 has a shelf life of 12 months after date of shipment in its original container.

General Information

Product selection table for $3M^{\scriptscriptstyle TM}$ Thermally Conductive Materials.

Product	Thickness (mm)	Bulk Thermal Conductivity (W/m-K)	Typical Applications			
3M™ Thermally Conductive Tapes						
8805	0.127	0.6	Applications requiring thin bonding with good thermal transfer; CPU, flex			
8810	0.25		circuit and power transformer bonding to heat sinks and other cooling devices. Superior tack and wetting properties.			
8815	0.375		dovided. Superior task and working proportion.			
8820	0.50					
9889FR	1.0	0.5	Applications requiring gap filling and bonding with good thermal transfer; plasma display, IC packages and PCB bonding to heat sinks, metal cases and other cooling devices.			
3M™ Thermally Conductive Pads						
5516/5516S	0.5, 1.0, 1.5, 2.0	2.3	Applications requiring gap filling and superior thermal performance			
5519/5519S	0.5, 1.0, 1.5, 2.0	4.3	without bonding. IC package and PCB thermal interfacing with heat sinks or other cooling devices and metal cases.			
5591S	0.5, 1.0, 1.5, 2.0	1.0	of other occurring devices and motal occor.			
5592/5592S	0.5, 1.0, 1.5, 2.0	1.1				
5595/5595S	0.5, 1.0, 1.5, 2.0	1.6				
3M™ Thermally Conductive Pads (Acrylic)						
5598H	1.0, 1.5	2.0	These pads use an acrylic elastomer for applications that require a non-			
5590H	0.5, 1.0, 1.5	3.0	silicone thermal pad. Provides IC package and PCB thermal interfacing with heat sinks or other cooling devices, and metal cases.			
3M™ Thermally Conductive Epoxy Adhesives						
TC-2810 DP-190 Gray	_ _	1.0 0.4	Applications requiring high adhesive strength, good surface wet-out, gap filling and good thermal transfer. Provides IC package and PCB thermal interfacing with heat sinks or other cooling devices.			

Only the "S" versions are available in 0.5 mm thicknesses.

[&]quot;S" designation signifies a polyester film on one side to provide a non-tacky surface.

[&]quot;H" designation signifies a product with one one-tacky surface without the use of PET film.

Precautionary Information

Refer to Product Label and Material Safety Data Sheet for Health and Safety Information before using this product. For additional health and safety information, call 1-800-364-3577 or (651) 737-6501.

For Additional Information

To request additional product information or to arrange for sales assistance, call toll free 1-800-251-8634. Address correspondence to: 3M Electronics Markets Materials Division, Building 21-1W-10, 900 Bush Avenue, St. Paul, MN 55144-1000. Our fax number is 651-778-4244 or 1-877-369-2923. In Canada, phone: 1-800-364-3577. In Puerto Rico, phone: 1-787-750-3000. In Mexico, phone: 52-70-04-00.

Important Notice

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3M Center, Building 21-1W-10, 900 Bush Avenue St. Paul, MN 55144-1000 1-800-251-8634 phone 651-778-4244 fax www.3M.com/electronics



